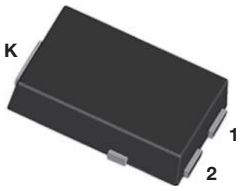
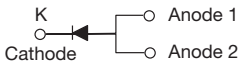
# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F$ = 0.39 V at $I_F$ = 4 A

eSMP® Series




SMPC (TO-277A)




## FEATURES

- Very low profile - typical height of 1.1 mm
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE Available

RoHS COMPLIANT

HALOGEN FREE

## DESIGN SUPPORT TOOLS

click logo to get started

3D Models Available

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPC (TO-277A)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS | |
|---|---|
| $I_{F(AV)}$ | 8.0 A |
| $V_{RRM}$ | 60 V |
| $I_{FSM}$ | 140 A |
| $V_F$ at $I_F$ = 8.0 A ($T_A$ = 125 °C) | 0.52 V |
| $T_J$ max. | 175 °C |
| Package | SMPC (TO-277A) |
| Circuit configuration | Single |

**MAXIMUM RATINGS** ($T_A$ = 25 °C unless otherwise noted)

| PARAMETER | SYMBOL | V8PM6 | UNIT |
|---|---|---|---|
| Device marking code | | V8M6 | |
| Maximum repetitive peak reverse voltage | $V_{RRM}$ | 60 | V |
| Maximum average forward rectified current (fig. 1) | $I_F$ (1) | 8.0 | A |
| | $I_F$ (2) | 4.3 | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $I_{FSM}$ | 140 | A |
| Operating junction temperature range | $T_J$ (3) | -40 to +175 | °C |
| Storage temperature range | $T_{STG}$ | -55 to +175 | °C |

**Notes**

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
(2) Free air, mounted on recommended copper pad area
(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

| **ELECTRICAL CHARACTERISTICS** ($T_A$ = 25 °C unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **TEST CONDITIONS** | | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Instantaneous forward voltage | $I_F$ = 4.0 A | $T_A$ = 25 °C | $V_F$ (1) | 0.50 | - | V |
| | $I_F$ = 8.0 A | | | 0.58 | 0.64 | |
| | $I_F$ = 4.0 A | $T_A$ = 125 °C | | 0.39 | - | |
| | $I_F$ = 8.0 A | | | 0.52 | 0.60 | |
| Reverse current | $V_R$ = 60 V | $T_A$ = 25 °C | $I_R$ (2) | - | 0.6 | mA |
| | | $T_A$ = 125 °C | | 3.5 | 14 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | $C_J$ | 1150 | - | pF |

**Notes**
(1) Pulse test: 300 µs pulse width, 1 % duty cycle
(2) Pulse test: pulse width ≤ 5 ms

| **THERMAL CHARACTERISTICS** ($T_A$ = 25 °C unless otherwise noted) | | | |
|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **V8PM6** | **UNIT** |
| Typical thermal resistance | $R_{\theta JA}$ (1)(2) | 75 | °C/W |
| | $R_{\theta JM}$ (3) | 4 | |

**Notes**
(1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction to mount

| **ORDERING INFORMATION** (Example) | | | | |
|---|---|---|---|---|
| **PREFERRED P/N** | **UNIT WEIGHT (g)** | **PREFERRED PACKAGE CODE** | **BASE QUANTITY** | **DELIVERY MODE** |
| V8PM6-M3/H | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V8PM6-M3/I | 0.10 | I | 6500 | 13" diameter plastic tape and reel |
| V8PM6HM3/H (1) | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V8PM6HM3/I (1) | 0.10 | I | 6500 | 13" diameter plastic tape and reel |

**Note**
(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES ($T_A$ = 25 °C unless otherwise noted)

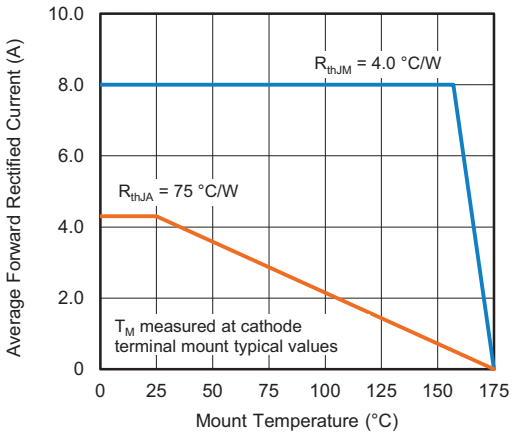



Fig. 1 - Forward Current Derating Curve

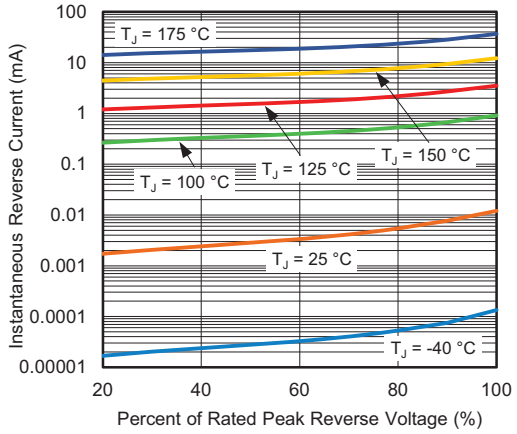



Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

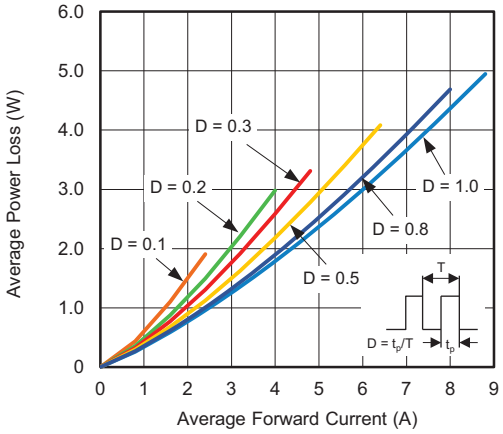



Fig. 2 - Forward Power Loss Characteristics

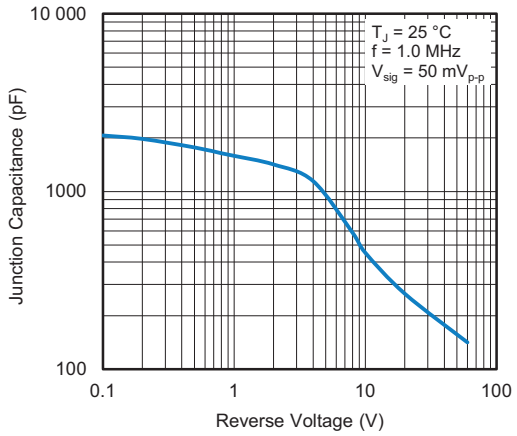



Fig. 5 - Typical Junction Capacitance

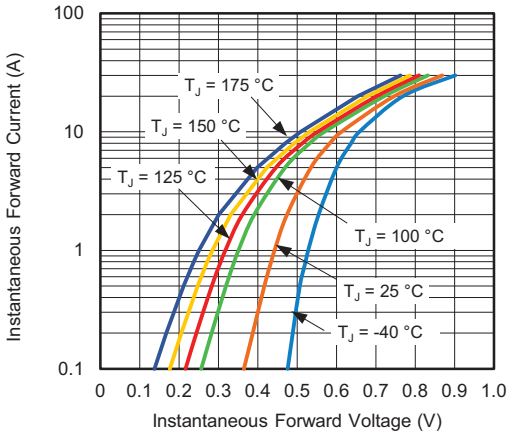



Fig. 3 - Typical Instantaneous Forward Characteristics

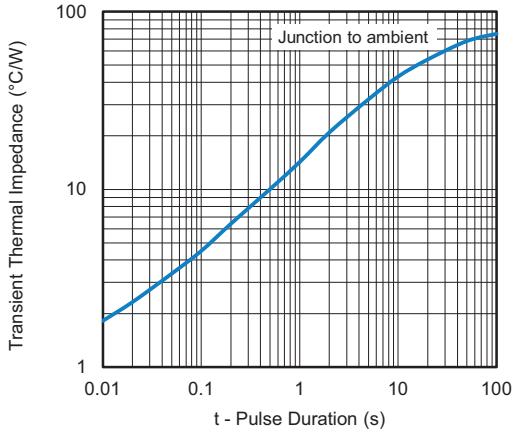
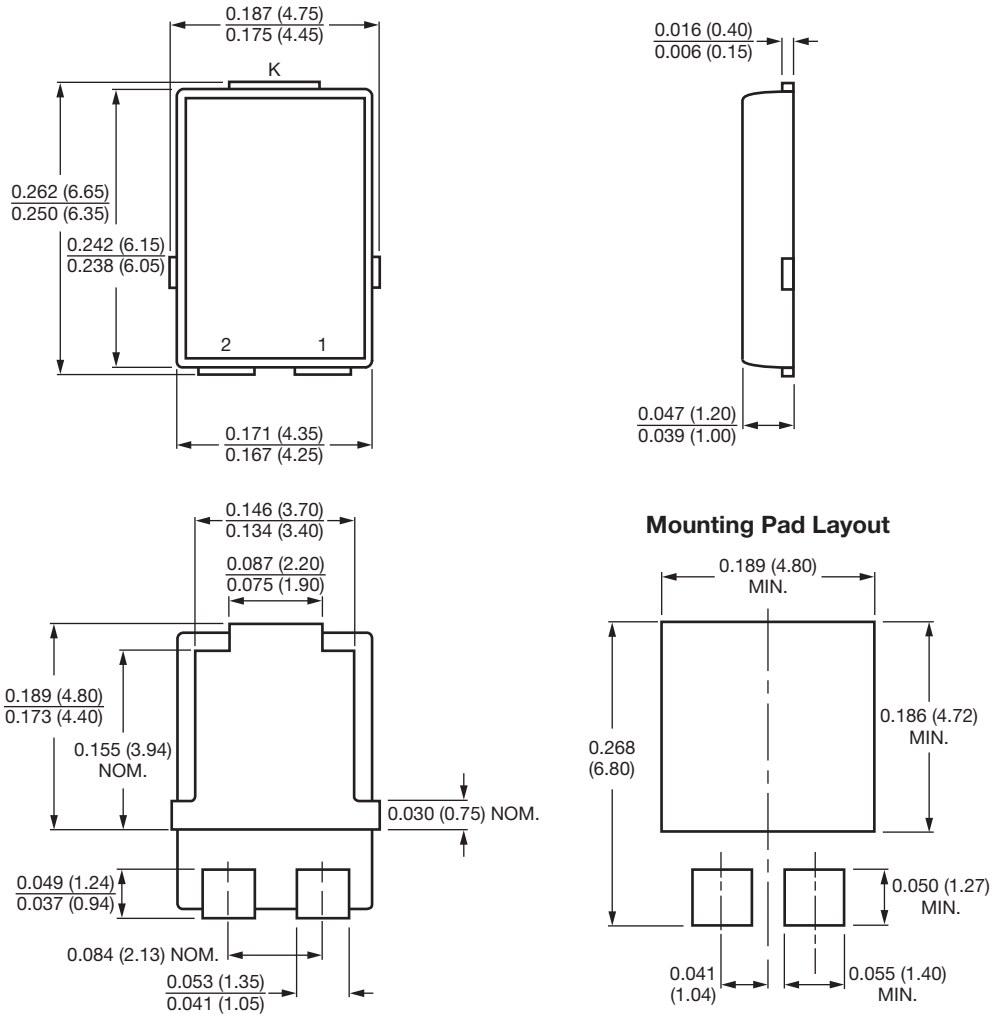



Fig. 6 - Typical Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**SMPC (TO-277A)**




Conform to JEDEC® TO-277A

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